



ESP32-C61

Series SoC Errata Version v1.0

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1 Chip Revision Identification

Espressif is introducing a new **vM.X** numbering scheme to indicate chip revisions. This guide outlines the structure of this scheme and provides information on chip errata and additional identification methods.

1.1 Chip Revision Numbering Scheme

The new numbering scheme **vM.X** consists of the major and minor numbers described below.

M –Major number, indicating the major revision of the chip product. If this number changes, it means the software used for the previous version of the product is incompatible with the new product, and the software version shall be upgraded for the use of the new product.

X –Minor number, indicating the minor revision of the chip product. If this number changes, it means the software used for the previous version of the product is compatible with the new product, and there is no need to upgrade the software.

The **vM.X** scheme replaces previously used chip revision schemes, including ECOx numbers, Vxxx, and other formats if any.

1.2 Primary Identification Methods

eFuse Bits

The chip revision is encoded using two eFuse fields:

- EFUSE_RD_MAC_SYS2_REG[3:0]
- EFUSE_RD_MAC_SYS2_REG[5:4]

Table 1.1: Chip Revision Identification by eFuse Bits

	eFuse Bit	Chip Revision			
		v0.0	v0.1	v0.2	v1.0
Major Number	EFUSE_RD_MAC_SYS2_REG[5]	0	0	0	0
	EFUSE_RD_MAC_SYS2_REG[4]	0	0	0	1
Minor Number	EFUSE_RD_MAC_SYS2_REG[3]	0	0	0	0
	EFUSE_RD_MAC_SYS2_REG[2]	0	0	0	0
	EFUSE_RD_MAC_SYS2_REG[1]	0	0	1	0
	EFUSE_RD_MAC_SYS2_REG[0]	0	1	0	0

Chip Marking

- **Manufacturing Code** line in chip marking

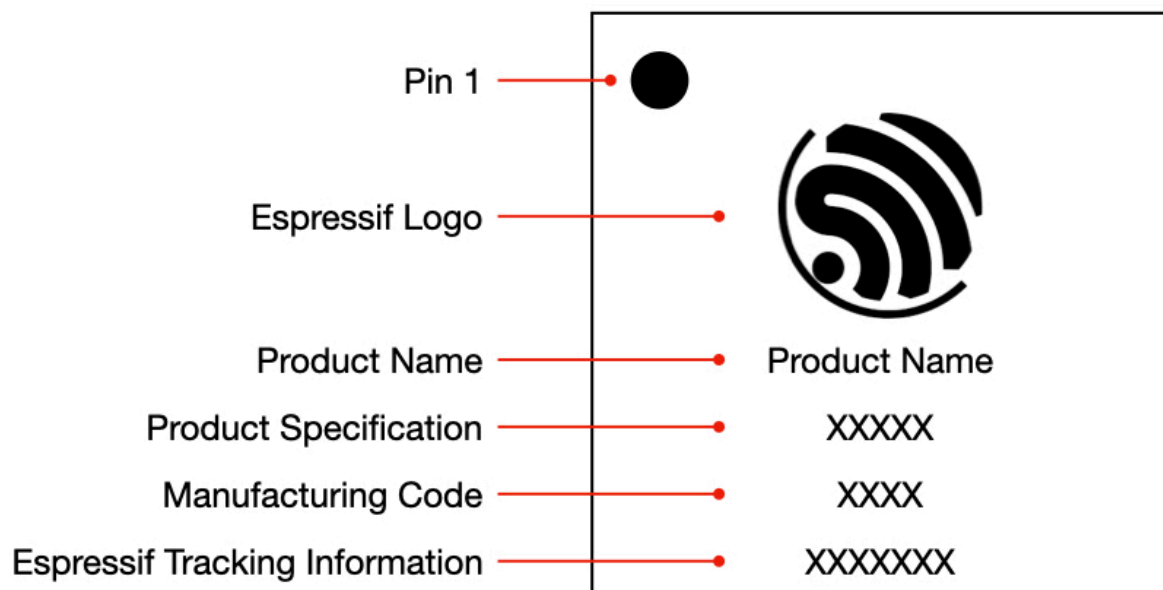


Figure 1.1: Chip Marking Diagram

Table 1.2: Chip Revision Identification by Chip Marking

Chip Revision	Manufacturing Code
v0.0	X A XX
v0.1	X B XX
v0.2	X C XX
v1.0	X D XX

Module Marking

- **Specification Identifier** line in module marking

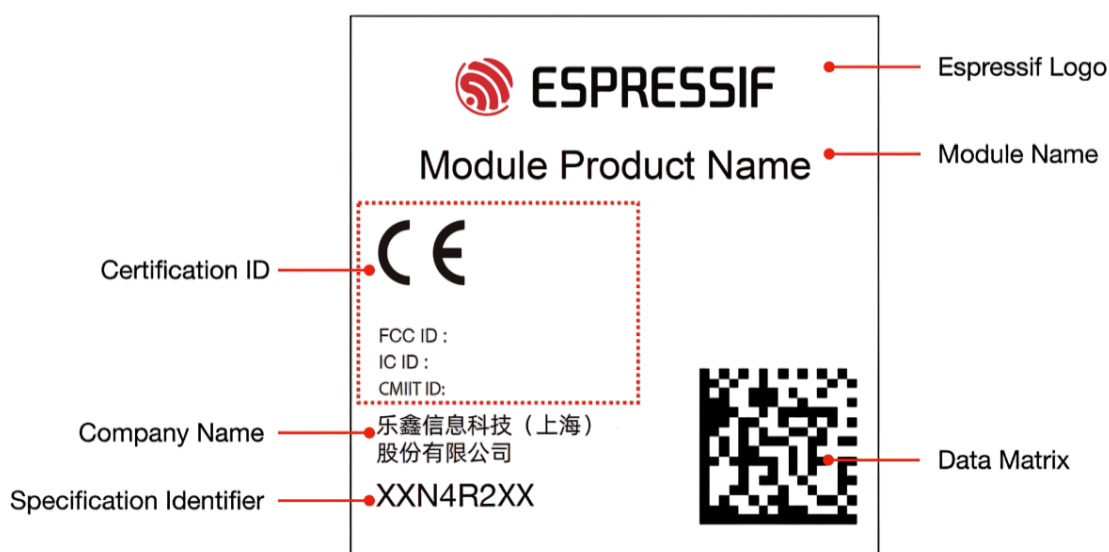


Figure 1.2: Module Marking Diagram

Table 1.3: Chip Revision Identification by Module Marking

Chip Revision	Specification Identifier
v0.0	XA XXXX
v0.1	MB XXXX
v0.2	MC XXXX
v1.0	MD XXXX

1.3 Additional Identification Methods

Date Code

Some errors in the chip product don't need to be fixed at the silicon level, or in other words in a new chip revision.

In this case, the chip may be identified by **Date Code** in chip marking (see [Chip Marking](#)). For more information, please refer to [ESP32-C61 Chip Packaging Information > Chip Silk Marking](#).

PW Number

Modules built around the chip may be identified by **PW Number** in product label (see [Module Product Label](#)). For more information, please refer to [ESP32-C61 Module Packaging Information > Pizza Box](#).

**ESPRESSIF**
乐鑫信息科技(上海)股份有限公司

生产工单	PW Number	PW-2020-11-0001
产品型号	Product Name	ESP32-WROOM-32D
产品料号	Product Number	M21EH3264PH3Q0
数量	Quantity	650 pcs
固件版本	Firmware Ver	IDF: AT: FW P/N:
原产国	Country of Origin	MADE IN CHINA
生产日期	Seal Date	2020-11-30
批次号	Lot Number	202048-000001 202048-000002 202048-000003 202048-000004 202048-000005
出货检验	OQC	产品条码 QR code



Figure 1.3: Module Product Label

Note: Please note that **PW Number** is only provided for reels packaged in aluminum moisture barrier bags (MBB).

1.4 ESP-IDF Release Compatibility

Information about ESP-IDF release that supports a specific chip revision is provided in [Compatibility Between ESP-IDF Releases and Revisions of Espressif SoCs](#).

1.5 Related Documents

- For more information about the chip revision upgrade and their identification of series products, please refer to [ESP32-C61 Product/Process Change Notifications \(PCN\)](#).
- For more information about the chip revision numbering scheme, see [Compatibility Advisory for Chip Revision Numbering Scheme](#).

2 Errata Summary

Table 2.1: Errata summary

Category	Errata No.	Descriptions	Affected Revisions			
			v0.0	v0.1	v0.2	v1.0
RISC-V CPU	CPU-718	[CPU-718] PSRAM Read-After-Write Consistency	Y	Y	Y	Y

3 All Errata Descriptions

3.1 [CPU-718] PSRAM Read-After-Write Consistency

Affected revisions: v0.0 v0.1 v0.2 v1.0

Description

When the CPU performs random read or write accesses to PSRAM through CACHE or DMA, and one of the following conditions is true:

- PSRAM encryption or decryption is enabled, or
- When accessing PSRAM via DMA, AHB_DMA_OUT_DATA_BURST_MODE_SEL_CHn is set to 0 or 1.

Data-consistency issues may occur for CPU accesses to PSRAM.

Cause The MSPI hardware handles CPU read or write requests to PSRAM and uses an internal buffer or cache. Because of this buffering (and encryption or decryption latency), CPU read or write requests received by MSPI are not always executed on the SPI bus immediately.

If the CPU performs a write to a PSRAM address and then quickly issues a read to the same physical address, the write may still be delayed inside MSPI. In that case, MSPI can execute the read before the earlier write has actually completed on the PSRAM, leading to stale or inconsistent data being returned.

Examples

- If CACHE reads from an encrypted or decrypted PSRAM region and a cache miss occurs, the data written back can be inconsistent.
- After a DMA write to PSRAM completes, a subsequent DMA read or CACHE read of the same PSRAM region may return inconsistent data.

Workarounds

- For consistency problems caused by cache misses during encryption or decryption: Avoid enabling PSRAM encryption in workloads that perform random read or write access.
- For consistency problems when the CPU accesses PSRAM via DMA: Insert a short delay after the DMA write finishes, or before the CPU reads the same physical address, to ensure MSPI has completed the actual PSRAM write.

Solution

To be fixed in the next chip revision.

4 Revision History

Table 4.1: Revision History

Date	Version	Release Notes
2025-11-20	v1.0	First release

5 Related Documentation and Resources

5.1 Related Documentation

- [ESP32-C61 Datasheet](#) –Specifications of the ESP32-C61 hardware.
- [ESP32-C61 Technical Reference Manual](#) –Detailed information on how to use the ESP32-C61 memory and peripherals.

- [ESP32-C61 Hardware Design Guidelines](#) –Guidelines on how to integrate the ESP32-C61 into your hardware product.
- Certificates
<https://espressif.com/en/support/documents/certificates>
- ESP32-C61 Product/Process Change Notifications (PCN)
<https://espressif.com/en/support/documents/pcns?keys=ESP32-C61>
- ESP32-C61 Advisories –Information on security, bugs, compatibility, component reliability.
<https://espressif.com/en/support/documents/advisories?keys=ESP32-C61>
- Documentation Updates and Update Notification Subscription
<https://espressif.com/en/support/download/documents>

5.2 Developer Zone

- [ESP-IDF Programming Guide for ESP32-C61](#) –Extensive documentation for the ESP-IDF development framework.
- ESP-IDF and other development frameworks on GitHub.
<https://github.com/espressif>
- ESP32 BBS Forum –Engineer-to-Engineer (E2E) Community for Espressif products where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.
<https://esp32.com/>
- The ESP Journal –Best Practices, Articles, and Notes from Espressif folks.
<https://blog.espressif.com/>
- See the tabs SDKs and Demos, Apps, Tools, AT Firmware.
<https://espressif.com/en/support/download/sdks-demos>

5.3 Products

- ESP32-C61 Series SoCs –Browse through all ESP32-C61 SoCs.
<https://espressif.com/en/products/socs?id=ESP32-C61>
- ESP32-C61 Series Modules –Browse through all ESP32-C61-based modules.
<https://espressif.com/en/products/modules?id=ESP32-C61>
- ESP32-C61 Series DevKits –Browse through all ESP32-C61-based devkits.
<https://espressif.com/en/products/devkits?id=ESP32-C61>
- ESP Product Selector –Find an Espressif hardware product suitable for your needs by comparing or applying filters.
<https://products.espressif.com/#/product-selector>

5.4 Contact Us

- See the tabs Sales Questions, Technical Enquiries, Circuit Schematic & PCB Design Review, Get Samples (Online stores), Become Our Supplier, Comments & Suggestions.
<https://espressif.com/en/contact-us/sales-questions>

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